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PATENT NUMBER and  
ISSUE DATE

5C1085 U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10002544	11/21/2001	205	157	1741	Leader

\*\*APPLICANTS: Liu Chung-Shi; Yu Chen-Hua;

\*\*CONTINUING DATA VERIFIED:

\*\* FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiner's initials		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 67,200-535
TITLE : Method for forming cathode contact areas for an electroplating process			

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drawg. Figs. Drawg. Print Fig.		
TERMINAL DISCLAIMER		Primary Examiner	Application Examiner	
		PREPARED FOR ISSUE		
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